



Overview

Canrez® CP75TA11 is Canyon's specialty translucent amber FFKM developed specifically for semiconductor manufacturing environments, plasma & laser applications, & high purity medical applications. Compare it to Kalrez 9100, 8085, and 6375.

Features & Benefits

- Ultra-high purity
- Low etch rate & low particle generation
- Near universal chemical resistance
- High resistance to plasma

Recommended Applications

- Semiconductor Dry & Wet
 - Ashing, etching, polishing, PVD, deposition, PECVD, LPCVD, SACVD, CVD, RPCVD, HDPCVD, APCVD, RTP, wafer cleaning, lamp anneal, metal & SiO₂ etching, CMP, Oxidation, litho, EPI +SiGe
- Medical, laser, & plasma applications

Service Temperature

- -10°C to 290°C (14°F to 554°F)

SEMICON

Nano-Poly Fill

CanRez



Test Data

Table 1. Physical Properties

| | |
|-----------------------------|-------------------|
| Color | Translucent Amber |
| Hardness, Shore A | 75 |
| Tensile Strength, psi (MPa) | 2509 (17.3) |
| Elongation | 159% |
| Fluorine Content, % | 72.7 |

Table 2. Compression Set

| | |
|----------------|-----|
| 70hrs at 200°C | 19% |
| 70hrs at 290°C | 44% |

Plasma Exposure

Table 3. Direct Plasma Exposure (REI) Test Process Conditions

| Parameter | O ₂ | O ₂ + CF ₄ |
|---------------------------------|----------------|----------------------------------|
| Plasma Power, Watts | 150 | 200 |
| Pressure, mtorr | 350 | 280 |
| Heater Temperature, °C | RT | RT |
| Gas Flow O ₂ , SCCM | 20 | 10 |
| Gas Flow CF ₄ , SCCM | N/A | 100 |

Table 4. ICP Chamber Direct Plasma

| Gas | CP75TA11 | Competitor |
|--|----------|------------|
| O ₂ , Mass Loss % | 28 | 31.1 |
| O ₂ + CF ₄ , Mass Loss % | 34.8 | 37.5 |